


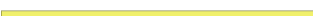
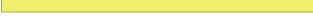










Board Stack Report

Stack Up		Layer Stack			
Layer	Board Layer Stack	Name	Material	Thickness	Constant
1		Top Paste			
2		Top Overlay			
3		Top Solder	Solder Resist	0.40mil	3.5
4		Top (L1)	Copper	1.40mil	
5		Dielectric 1	FR-4	10.00mil	3.67
6		L2	Copper	1.40mil	
7		Dielectric 3		36.00mil	3.67
8		L3	Copper	1.40mil	
9		Dielectric 4		10.00mil	3.67
10		Bottom (L4)	Copper	1.40mil	
11		Bottom Solder	Solder Resist	0.40mil	3.5
12		Bottom Overlay			
13		Bottom Paste			
Height : 62.40mil					